

### **PUR2060**

# Polyurethane Reactive Hot-Melt Adhesive

#### **DESCRIPTION**

**PUR2060** is a reactive hot melt moisture cure urethane adhesive used in structural applications, such as lamination of wood, wood products, metal, honeycombs structures and EPS. The low viscosity and moderate open time of **PUR2060** make this a versatile adhesive for use in many applications. **PUR2060** was formulated as a 100% solids product to replace solvent based contact adhesives to provide complete elimination of VOC.

#### **CLEAN UP**

For cleaning of equipment any uncured material, NMP (N-Methyl Pyrrolidinone) or DBE (Dibasic Ester) are recommended. To remove cured materials, the use of chemical stripper such as Methylene Chloride is suggested.

TYPICAL PROPERTIES (cured Days at° F)	TEST METHOD	<u>VALUE</u>
Lap Shear [CRS to CRS] (psi):	ASTM D1002	>1500
Tensile Strength (psi):	ASTM D638	3700
Tensile Modulus (psi):		13000
Elongation (%):		800
Product:		
Viscosity (cps):	ASTM D2393	10000 at 77°C
Color:		White (Solid)
		Amber (Liquid)

To the best of our knowledge, the information contained herein is accurate. However, STAR TECHNOLOGY, Inc., does not assume any liability whatsoever for the accuracy or completeness of the information contained herein. Final determination of the suitability of any material is the sole responsibility of the user. The information contained herein is considered typical properties and is not intended to be used as specifications for our products. This information is offered solely to assist purchaser in selecting the appropriate products for purchaser's own testing. All materials may present unknown hazards and should be used with caution. Although certain hazards are described herein and in the material safety data sheet, we cannot guarantee that these are the only hazards that exist. Repeated and prolonged exposure to epoxy resins can cause sensitization or other allergic responses.



## **PUR2060**

## Polyurethane Reactive Hot-Melt Adhesive

### **PRODUCT NOTES**

**PUR2060** is formulated for application at a temperature of 77°C. Cure is affected by reacting with ambient moisture in the air and in the substrates. No open time is required, lamination can be assembled once adhesive is applied to clean, dry substrates free from any grease, oil, wax or other surface contaminates. Recommended bond line is 3 to 5 mils.

As with all moisture cure urethane products, the adhesive must be stored under anhydrous conditions.

\*Fire resistant hydraulic fluids.

#### **PRECAUTIONS**

For industrial use only. Keep away from children.

Refer to the Material Safety Data Sheets (MSDS forms) pertaining to this product before using.

Avoid contact with skin or eyes. In the event of an eye splash or contact, immediately flush with cold water for 15 minutes and contact a physician. If skin contact occurs, wash with mild soap and water. The wearing of safety glasses with side shields and impervious gloves is recommended.

### PRODUCT WARNING STATEMENT

May cause allergic skin reaction. Avoid all contact with skin, eyes, and clothing. Wash thoroughly after handling.

To the best of our knowledge, the information contained herein is accurate. However, STAR TECHNOLOGY, Inc., does not assume any liability whatsoever for the accuracy or completeness of the information contained herein. Final determination of the suitability of any material is the sole responsibility of the user. The information contained herein is considered typical properties and is not intended to be used as specifications for our products. This information is offered solely to assist purchaser in selecting the appropriate products for purchaser's own testing. All materials may present unknown hazards and should be used with caution. Although certain hazards are described herein and in the material safety data sheet, we cannot guarantee that these are the only hazards that exist. Repeated and prolonged exposure to epoxy resins can cause sensitization or other allergic responses.